

#### **Features**

- ◆ Ideal for high-performance processor secondary cache
- ◆ Commercial (0°C to +70°C) and Industrial (-40°C to +85°C) temperature range options
- Fast access times:
  - Commercial and Industrial: 12/15/20ns
- Low standby current (maximum):
  - 2mA full standby
- Small packages for space-efficient layouts:
  - 28-pin 300 mil SOJ
  - 28-pin TSOP Type I
- Produced with advanced high-performance CMOS technology
- Inputs and outputs are LVTTL-compatible
- Single 3.3V(±0.3V) power supply
- Green parts available, see ordering information

### **Description**

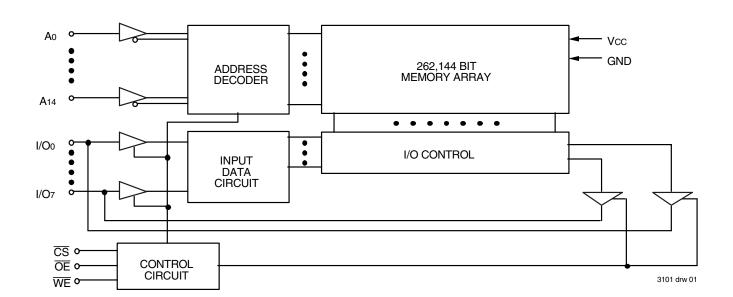
The IDT71V256SA is a 262,144-bit high-speed static RAM organized as 32Kx8. It is fabricated using a high-performance, high-reliability CMOS technology.

The IDT71V256SA has outstanding low power characteristics while at the same time maintaining very high performance. Address access times of as fast as 12ns are ideal for 3.3V secondary cache in 3.3V desktop designs.

When power management logic puts the IDT71V256SA in standby mode, its very low power characteristics contribute to extended battery life. By taking  $\overline{CS}$  HIGH, the SRAM will automatically go to a low power standby mode and will remain in standby as long as  $\overline{CS}$  remains HIGH. Furthermore, under full standby mode ( $\overline{CS}$  at CMOS level, f=0), power consumption is guaranteed to always be less than 6.6mW and typically will be much smaller.

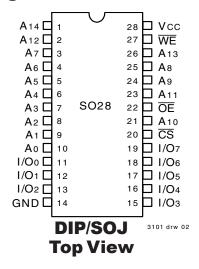
The IDT71V256SA is packaged in a 28-pin 300 mil SOJ and a 28-pin 300 mil TSOP Type I.

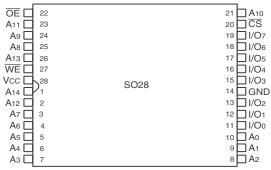
### **Functional Block Diagram**



**AUGUST 2015** 

### **Pin Configurations**





TSOP Top View

# **Pin Descriptions**

Name	Description
A0 - A14	Addresses
I/O0 - I/O7	Data Input/Output
<del>C</del> <del>S</del>	Chip Select
WE	Write Enable
ŌĒ	Output Enable
GND	Ground
Vcc	Power

3101 tbl 01

## Truth Table<sup>(1)</sup>

WE	CS	ŌĒ	I/O	Function
Х	Н	Χ	High-Z	Standby (ISB)
Х	VHC	Χ	High-Z	Standby (ISB1)
Н	L	Н	High-Z	Output Disable
Н	L	L	Douт	Read
L	L	Х	Din	Write

NOTE

1. H = VIH, L = VIL, X = Don't Care

# **Absolute Maximum Ratings**(1)

Symbol	Rating	Com'l.	Unit
Vcc	Vcc Supply Voltage Relative to GND		V
VTERM <sup>(2)</sup>	Terminal Voltage Relative to GND	-0.5 to Vcc+0.5	V
TBIAS	Temperature Under Bias	-55 to +125	°C
Tstg	Storage Temperature	-55 to +125	°C
Рт	Power Dissipation	1.0	W
Іоит	DC Output Current	50	mA

NOTES:

3101 drw 03

3101 tbl 03

3101 tbl 02

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS
  may cause permanent damage to the device. This is a stress rating only and
  functional operation of the device at these or any other conditions above those
  indicated in the operational sections of this specification is not implied. Exposure
  to absolute maximum rating conditions for extended periods may affect
  reliability.
- 2. Input, Output, and I/O terminals; 4.6V maximum.

### **Capacitance**

### $(TA = +25^{\circ}C, f = 1.0MHz, SOJ package)$

Symbol	Parameter <sup>(1)</sup>	Conditions	Max.	Unit
Cin	Input Capacitance	VIN = 3dV	6	pF
Соит	Output Capacitance	Vout = 3dV	7	pF

NOTE:

3101 tbl 04

 This parameter is determined by device characterization, but is not production tested

### Recommended Operating Temperature and Supply Voltage

Grade	Temperature	GND	Vcc
Commercial	0°C to +70°C	0V	3.3V ± 0.3V
Industrial	-40°C to +85°C	0V	3.3V ± 0.3V

3101 tbl 05

# Recommended DC Operating Conditions

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage	3.0	3.3	3.6	٧
GND	Ground	0	0	0	٧
VIH	Input High Voltage - Inputs	2.0	_	Vcc +0.3	٧
VIH	Input High Voltage - I/O	2.0	_	Vcc +0.3	٧
VIL	Input Low Voltage	-0.3(1)	_	0.8	V

NOTE:

3101 tbl 06

# **DC Electrical Characteristics**(1)

(Vcc = 3.3V ± 0.3V, VLc = 0.2V, VHC = Vcc - 0.2V, Commercial and Industrial Temperature Ranges)

Symbol	Parameter	71V256SA12	71V256SA15	71V256SA20	Unit
ICC	Dynamic Operating Current $\overline{\text{CS}} \leq \text{V}\text{\tiny{IL}}$ , Outputs Open, Vcc = Max., f = fmax <sup>(2)</sup>	90	85	85	mA
ISB	$\frac{\text{Standby Power Supply Current (TTL Level)}}{\overline{\text{CS}}} = \text{V}_{\text{IH}}, \text{Vcc} = \text{Max., Outputs Open, f} = \text{f}_{\text{MAX}}^{(2)}$		20	20	mA
ISB1	Full Standby Power Supply Current (CMOS Level) $\overline{\text{CS}} \geq \text{VHC}$ , Vcc = Max., Outputs Open, f = $0^{(2)}$ , VIN $\leq$ VLC or VIN $\geq$ VHC	2	2	2	mA

3101 tbl 07

#### NOTES:

- 1. All values are maximum guaranteed values.
- 2.  $f_{MAX} = 1/t_{RC}$ , only address inputs cycling at  $f_{MAX}$ ; f = 0 means that no inputs are cycling.

### **DC Electrical Characteristics**

 $(Vcc = 3.3V \pm 0.3V)$ 

			IDT71V256SA			
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
ILI	Input Leakage Current	Vcc = Max., Vin = GND to Vcc	_	_	2	μΑ
llo	Output Leakage Current	$Vcc = Max., \overline{CS} = ViH, VouT = GND to Vcc$	_	_	2	μA
Vol	Output Low Voltage	IoL = 8mA, Vcc = Min.	_	_	0.4	٧
Voh	Output High Voltage	loн = -4mA, Vcc = Min.	2.4	_	_	V

3101 tbl 08

<sup>1.</sup> VIL (min.) = -2.0V for pulse width less than 5ns, once per cycle.

### **AC Test Conditions**

Input Pulse Levels	GND to 3.0V
Input Rise/Fall Times	3ns
Input Timing Reference Levels	1.5V
Output Reference Levels	1.5V
AC Test Load	See Figures 1 and 2

3101 tbl 09

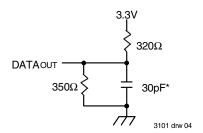


Figure 1. AC Test Load

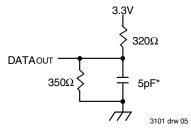


Figure 2. AC Test Load (for tclz, tolz, tchz, tohz, tow, twhz)

\*Includes scope and jig capacitances

### **AC Electrical Characteristics**

### (Vcc = 3.3V ± 0.3V, Commercial and Industrial Temperature Ranges)

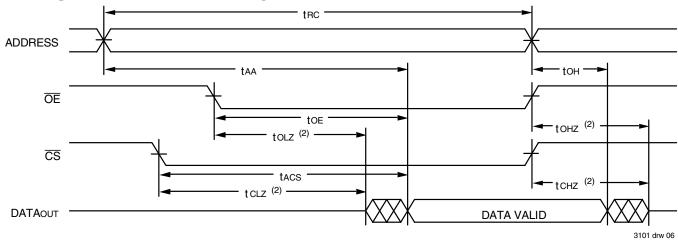
		71V25	6SA12	71V25	6SA15	71V25	6SA20	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
Read Cy	Read Cycle							
trc	Read Cycle Time	12		15	_	20	_	ns
taa	Address Access Time		12	_	15		20	ns
tacs	Chip Select Access Time		12		15		20	ns
tcLz <sup>(1)</sup>	Chip Select to Output in Low-Z	5		5		5	_	ns
tcHz <sup>(1)</sup>	Chip Select to Output in High-Z	0	8	0	9	0	10	ns
toE	Output Enable to Output Valid		6		7		8	ns
toLz <sup>(1)</sup>	Output Enable to Output in Low-Z	3		0		0		ns
tonz <sup>(1)</sup>	Output Disable to Output in High-Z	2	6	0	7	0	8	ns
toн	Output Hold from Address Change	3		3		3		ns
Write Cy	cle							
twc	Write Cycle Time	12		15	_	20	_	ns
taw	Address Valid to End-of-Write	9		10		15		ns
tcw	Chip Select to End-of-Write	9		10		15		ns
tas	Address Set-up Time	0		0		0		ns
twp	Write Pulse Width	9		10		15		ns
twr	Write Recovery Time	0		0		0		ns
tow	Data to Write Time Overlap	6		7		8		ns
tон	Data Hold from Write Time	0		0		0		ns
tow <sup>(1)</sup>	Output Active from End-of-Write	4		4		4		ns
twnz <sup>(1)</sup>	Write Enable to Output in High-Z	1	8	1	9	1	10	ns

3101 tbl 10

#### NOTE:

<sup>1.</sup> This parameter guaranteed with the AC test load (Figure 2) by device characterization, but is not production tested.

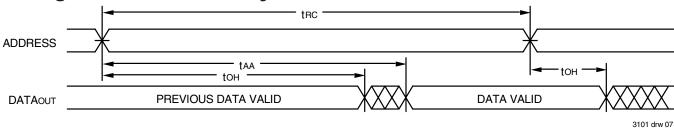
# Timing Waveform of Read Cycle No. 1<sup>(1)</sup>



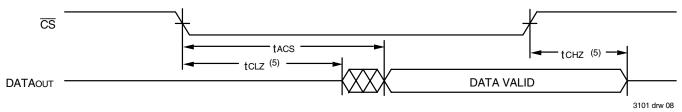
#### NOTES:

- 1. WE is HIGH for Read cycle.
- 2. Transition is measured ±200mV from steady state.

# Timing Waveform of Read Cycle No. 2<sup>(1,2,4)</sup>



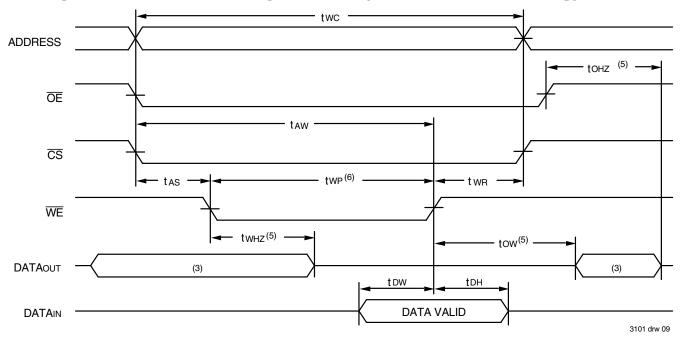
# Timing Waveform of Read Cycle No. 3<sup>(1,3,4)</sup>



### NOTES:

- 1. WE is HIGH for Read cycle.
- 2. Device is continuously selected,  $\overline{\text{CS}}$  is LOW.
- 3. Address valid prior to or coincident with  $\overline{\text{CS}}$  transition LOW.
- 4.  $\overline{\sf OE}$  is LOW.
- 5. Transition is measured ±200mV from steady state.

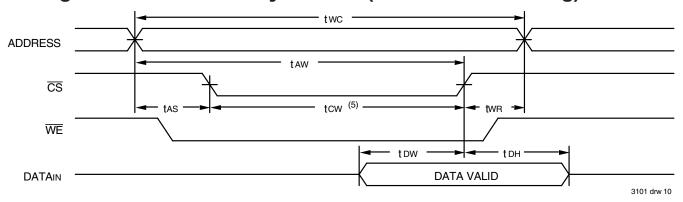
# Timing Waveform of Write Cycle No. 1 (WE Controlled Timing)(1,2,4,6)



#### NOTES:

- 1. A write occurs during the overlap of a LOW  $\overline{\text{CS}}$  and a LOW  $\overline{\text{WE}}$ .
- 2. twn is measured from the earlier of  $\overline{CS}$  or  $\overline{WE}$  going HIGH to the end of the write cycle.
- 3. During this period, I/O pins are in the output state so that the input signals must not be applied.
- 4. If the CS LOW transition occurs simultaneously with or after the WE LOW transition, the outputs remain in a high-impedance state.
- 5. Transition is measured ±200mV from steady state.
- 6. If  $\overline{OE}$  is LOW during a  $\overline{WE}$  controlled write cycle, the write pulse width must be the larger of twp or (twHz + tDW) to allow the I/O drivers to turn off and data to be placed on the bus for the required tDW. If  $\overline{OE}$  is HIGH during a  $\overline{WE}$  controlled write cycle, this requirement does not apply and the write pulse can be as short as the spectified twp.

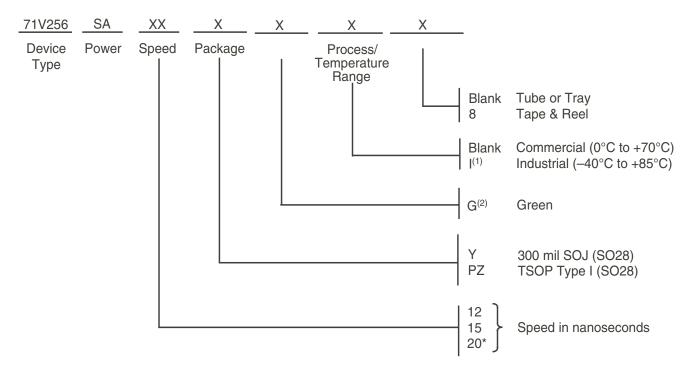
# Timing Waveform of Write Cycle No. 2 (CS Controlled Timing)(1,2,3,4)



#### NOTES

- 1. WE or CS must be HIGH during all address transitions.
- 2. A write occurs during the overlap of a LOW  $\overline{\text{CS}}$  and a LOW  $\overline{\text{WE}}$ .
- 3. twn is measured from the earlier of  $\overline{CS}$  or  $\overline{WE}$  going HIGH to the end of the write cycle.
- 4. If the CS LOW transition occurs simultaneously with or after the WE LOW transition, the outputs remain in a high-impedance state.
- 5. If  $\overline{OE}$  is LOW during a  $\overline{WE}$  controlled write cycle, the write pulse width must be the larger of twp or (twHz + tDW) to allow the I/O drivers to turn off and data to be placed on the bus for the required tDW. If  $\overline{OE}$  is HIGH during a  $\overline{WE}$  controlled write cycle, this requirement does not apply and the write pulse can be as short as the spectified twp.

# ${\bf Ordering\ Information-Commercial\ and\ Industrial}$



<sup>\*</sup> Available in TSOP package only.

3101 drw 11

#### NOTES:

- $1. \quad \text{Contact your local sales of fice for industrial temp. range for other speeds, packages and powers.} \\$
- 2. Green parts available. For specific speeds, packages and powers contact your local sales office.

# **Datasheet Document History**

1/7/00		Updated to new format
	Pg. 1, 3, 4, 7	Expanded Industrial Temperature offerings
	Pg. 1, 2, 7	Removed 28-pin 300 mil plastic DIP package offering
	Pg. 6	Removed Note No. 1 from Write Cycle No. 1 diagram; renumbered notes and footnotes
	Pg. 7	Revised Ordering Information
	Pg. 8	Added Datasheet Document History
08/09/00	· ·	Not recommended for new designs
02/01/01		Removed "Not recommended for new designs"
06/21/02	Pg. 7	Added tape and reel option to the ordering information
01/30/04	Pg. 7	Added "restricted hazardous substance device" to order information.
02/20/09	Pg. 7	Removed "IDT" from ordering parts
06/11/12	Pg. 3	Corrected Recommended DC Operation Conditions Max VIH from 5.0 to Vcc+0.3V
	Pg. 7	Added Green designator to ordering information
	Pg. 7	Corrected footnote in the ordering information from "available in SOJ package only" to
		"available in TSOP package only"
07/24/14	Pg.7	Added tube or tray to the ordering information
08/18/15	Pg.1 & 7	Removed commercial 10ns speed offering & added green parts available to features
	Pg.2 & 7	Removed "-X" extensions from all pin configurations SOJ28 & TSOP28
	Pg. 3 & 4	Removed commercial 10ns speed offering columns from the DC & AC Elec tables
	Pg.7	Updated the Industrial and Green footnotes in the Ordering Information
	-	•



CORPORATE HEADQUARTERS

6024 Silver Creek Valley Road San Jose, CA 95138 for SALES: 800-345-7015 or 408-284-8200 fax: 408-284-2775 www.idt.com for Tech Support: sramhelp@idt.com 408-284-4532

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for SRAM category:

Click to view products by IDT manufacturer:

Other Similar products are found below:

5962-8855206XA CY6116A-35DMB CY7C128A-45DMB CY7C1461KV33-133AXI CY7C199-45LMB CYDM128B16-55BVXIT
GS8161Z36DD-200I GS88237CB-200I R1QDA7236ABB-20IB0 RMLV0408EGSB-4S2#AA0 IS64WV3216BLL-15CTLA3
IS66WVE4M16ECLL-70BLI PCF8570P K6T4008C1B-GB70 CY7C1353S-100AXC AS6C8016-55BIN 515712X IS62WV51216EBLL45BLI IS63WV1288DBLL-10HLI IS66WVE2M16ECLL-70BLI 47L16-E/SN IS66WVE4M16EALL-70BLI IS62WV6416DBLL-45BLI
IS61WV102416DBLL-10TLI CY7C1381KV33-100AXC CY7C1381KV33-100BZXI CY7C1373KV33-100AXC CY7C1381KVE33-133AXI
CY7C4042KV13-933FCXC 8602501XA 5962-3829425MUA 5962-8855206YA 5962-8866201XA 5962-8866201YA 5962-8866204TA
5962-8866206MA 5962-8866207NA 5962-8866208UA 5962-8872502XA 5962-8959836MZA 5962-8959841MZA 5962-9062007MXA
5962-9161705MXA N08L63W2AB7I 7130LA100PDG GS81284Z36B-250I M38510/28902BVA IS62WV12816ALL-70BLI 59628971203XA 5962-8971202ZA